

Data Sheet

#### February 19, 2004

专业PCB打样工

FN7104.5

EL8102, EL8103

### 500MHz Rail-to-Rail Amplifiers



Ordering Information

The EL8102, EL8103 represent single rail-to-rail amplifiers with a -3dB bandwidth of 500MHz and slew

rate of 600V/ $\mu$ s. Running off a very low 5.6mA supply current, the EL8102, EL8103 also feature inputs that go to 0.15V below the V<sub>S</sub>- rail.

The EL8102 includes a fast-acting disable/power-down circuit. With a 25ns disable and a 200ns enable, the EL8102 is ideal for multiplexing applications.

The EL8102, EL8103 are designed for a number of general purpose video, communication, instrumentation, and industrial applications. The EL8102 is available in 8-pin SO and 6-pin SOT-23 packages and the EL8103 is available in a 5-pin SOT-23 package. All are specified for operation over the -40°C to +85°C temperature range.

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PART NUMBER	PACKAGE	TAPE & REEL	PKG. DWG. #
EL8102IS	8-Pin SO	-	MDP0027
EL8102IS-T7	8-Pin SO	7"	MDP0027
EL8102IS-T13	8-Pin SO	13"	MDP0027
EL8102IW-T7	6-Pin SOT-23	7" (3K pcs)	MDP0038
EL8102IW-T7A	6-Pin SOT-23	7" (250 pcs)	MDP0038
EL8103IW-T7	5-Pin SOT23	7" (3K pcs)	MDP0038
EL8103IW-T7A	5-Pin SOT23	7" (250 pcs)	MDP0038

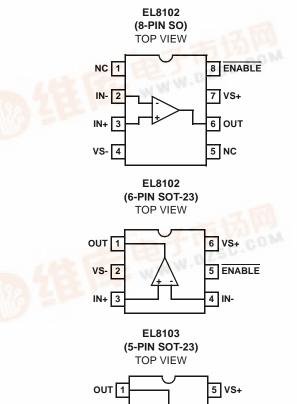
#### Features

- 500MHz -3dB bandwidth
- 600V/µs slew rate
- Low supply current = 5.6mA
- Supplies from 3V to 5.0V
- · Rail-to-rail output
- Input to 0.15V below V<sub>S</sub>-
- Fast 25ns disable (EL8102 only)
- Low cost

#### Applications

- Video amplifiers
- Portable/hand-held products
- Communications devices

#### **Pinouts**





4 IN-

VS- 2

IN+

#### Absolute Maximum Ratings $(T_A = 25^{\circ}C)$

Supply Voltage from V <sub>S</sub> + to V <sub>S</sub> 5.5V
Input Voltage $V_{S}$ + +0.3V to $V_{S}$ 0.3V
Differential Input Voltage2V
Continuous Output Current 40mA

Power Dissipation	See Curves
Storage Temperature65°C	C to +125°C
Ambient Operating Temperature40°	°C to +85°C
Operating Junction Temperature	+125°C

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

IMPORTANT NOTE: All parameters having Min/Max specifications are guaranteed. Typ values are for information purposes only. Unless otherwise noted, all tests are at the specified temperature and are pulsed tests, therefore:  $T_J = T_C = T_A$ 

**Electrical Specifications**  $V_{S}$ + = 5V,  $V_{S}$ - = GND,  $T_{A}$  = 25°C,  $V_{CM}$  = 2.5V,  $R_{L}$  to 2.5V,  $A_{V}$  = 1, Unless Otherwise Specified

PARAMETER	DESCRIPTION	CONDITIONS	MIN	TYP	MAX	UNIT
INPUT CHAR	ACTERISTICS		<u> </u>			
V <sub>OS</sub>	Offset Voltage		-8	-0.8	+8	mV
TCV <sub>OS</sub>	Offset Voltage Temperature Coefficient	Measured from T <sub>MIN</sub> to T <sub>MAX</sub>		3		μV/°C
IB	Input Bias Current	$V_{IN} = 0V$	-9	-6		μA
I <sub>OS</sub>	Input Offset Current	$V_{IN} = 0V$		0.1	0.6	μA
TCI <sub>OS</sub>	Input Bias Current Temperature Coefficient	Measured from $T_{MIN}$ to $T_{MAX}$		2		nA/°C
CMRR	Common Mode Rejection Ratio	V <sub>CM</sub> = -0.15V to +3.5V	70	95		dB
CMIR	Common Mode Input Range		V <sub>S</sub> 0.15		V <sub>S</sub> + -1.5	V
R <sub>IN</sub>	Input Resistance	Common Mode		3.5		MΩ
C <sub>IN</sub>	Input Capacitance			0.5		pF
AVOL	Open Loop Gain	$V_{OUT}$ = +1.5V to +3.5V, $R_L$ = 1k $\Omega$ to GND	75	90		dB
		$V_{OUT}$ = +1.5V to +3.5V, R <sub>L</sub> = 150 $\Omega$ to GND		80		dB
OUTPUT CHA	RACTERISTICS					
R <sub>OUT</sub>	Output Resistance	A <sub>V</sub> = +1		30		mΩ
V <sub>OP</sub>	Positive Output Voltage Swing	$R_L = 1k\Omega$	4.85	4.9		V
		$R_L = 150\Omega$	4.6	4.7		V
V <sub>ON</sub>	Negative Output Voltage Swing	$R_L = 150\Omega$		100	150	mV
		$R_L = 1k\Omega$		25	50	mV
I <sub>OUT</sub>	Linear Output Current			65		mA
I <sub>SC</sub> (source)	Short Circuit Current	$R_L = 10\Omega$	70	80		mA
I <sub>SC</sub> (sink)	Short Circuit Current	$R_L = 10\Omega$	120	150		mA
POWER SUP	PLY		1			
PSRR	Power Supply Rejection Ratio	V <sub>S</sub> + = 4.5V to 5.5V	70	95		dB
I <sub>S-ON</sub>	Supply Current - Enabled			5.6	6	mA
I <sub>S-OFF</sub>	Supply Current - Disabled			30		μA
ENABLE (EL8	102 ONLY)					
t <sub>EN</sub>	Enable Time			200		ns
t <sub>DS</sub>	Disable Time			25		ns
V <sub>IH-ENB</sub>	ENABLE Pin Voltage for Power-up			0.8		V
V <sub>IL-ENB</sub>	ENABLE Pin Voltage for Shut-down			2		V
I <sub>IH-ENB</sub>	ENABLE Pin Input Current High			8.6		μA
I <sub>IL-ENB</sub>	ENABLE Pin Input for Current Low			0.01		μA

2

# EL8102, EL8103

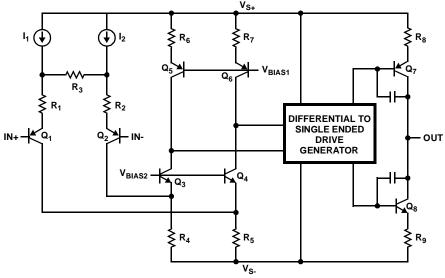
Electrical Specifications V <sub>S</sub> +	$5V$ , $V_{S}$ = GND, $T_{A}$ = 25°C, $V_{CM}$ = 2.5V, $R_{L}$ to 2.5V, $A_{V}$ = 1, Unless Otherwise Specified (C	Continued)
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PARAMETER	DESCRIPTION	CONDITIONS	MIN	TYP	MAX	UNIT
AC PERFORM	IANCE				ł	+
BW	-3dB Bandwidth	$A_V = \pm 1$ , $R_F = 0\Omega$ , $C_L = 5pF$		500		MHz
		$A_V = -1, R_F = 1k\Omega, C_L = 5pF$		140		MHz
		$A_V = +2$ , $R_F = 1k\Omega$ , $C_L = 5pF$		165		MHz
		$A_V = +10, R_F = 1k\Omega, C_L = 5pF$		18		MHz
BW	±0.1dB Bandwidth	$A_V = +1, R_F = 0\Omega, C_L = 5pF$		35		MHz
Peak	Peaking	$A_V = +1, R_L = 1k\Omega, C_L = 5pF$		1		dB
GBWP	Gain Bandwidth Product			200		MHz
PM	Phase Margin	$R_L = 1k\Omega, C_L = 5pF$		55		0
SR	Slew Rate	$A_V = 2$ , $R_L = 100\Omega$ , $V_{OUT} = 0.5V$ to 4.5V	500	600		V/µs
t <sub>R</sub>	Rise Time	2.5V <sub>STEP</sub> , 20% - 80%		4		ns
t <sub>F</sub>	Fall Time	2.5V <sub>STEP</sub> 20% - 80%		2		ns
OS	Overshoot	200mV step		10		%
t <sub>PD</sub>	Propagation Delay	200mV step		1		ns
t <sub>S</sub>	0.1% Settling Time	200mV step		15		ns
dG	Differential Gain	$A_V = +2, R_F = 1k\Omega, R_L = 150\Omega$		0.01		%
dP	Differential Phase	$A_V = +2, R_F = 1k\Omega, R_L = 150\Omega$		0.01		o
e <sub>N</sub>	Input Noise Voltage	f = 10kHz		12		nV/√Hz
i <sub>N</sub> +	Positive Input Noise Current	f = 10kHz		1.7		pA/√Hz
i <sub>N</sub> -	Negative Input Noise Current	f = 10kHz		1.3		pA/√Hz

# **Pin Descriptions**

PIN				
EL8102IS	EL8102IW	EL8103IW	NAME	FUNCTION
1			NC	Not connected
2	4	4	IN-	Inverting input
3	3	3	IN+	Non-inverting input
4	2	2	VS-	Negative power supply
5			NC	Not connected
6	1	1	OUT	Amplifier output
7	6	5	VS+	Positive power supply
8	5		ENABLE	Enable and disable input

Simplified Schematic Diagram





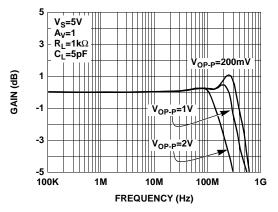


FIGURE 1. FREQUENCY RESPONSE FOR VARIOUS OUTPUT VOLTAGE LEVELS

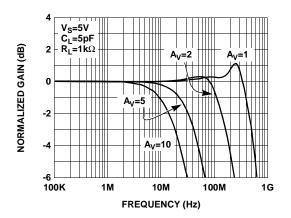


FIGURE 3. SMALL SIGNAL FREQUENCY RESPONSE FOR VARIOUS NON-INVERTING GAINS

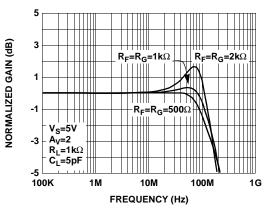
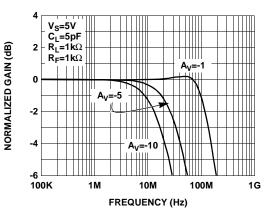
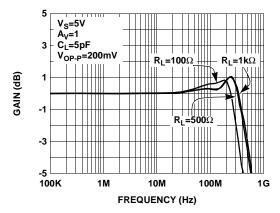


FIGURE 2. SMALL SIGNAL FREQUENCY RESPONSE vs  $R_{\rm F}$  AND  $R_{\rm G}$ 









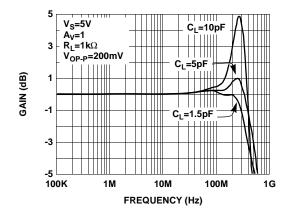


FIGURE 7. SMALL SIGNAL FREQUENCY RESPONSE vs CL

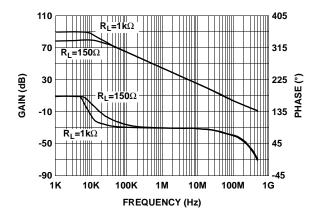


FIGURE 9. OPEN LOOP GAIN AND PHASE vs FREQUENCY

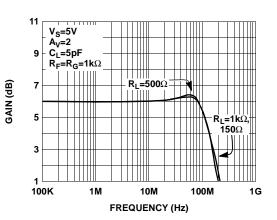


FIGURE 6. SMALL SIGNAL FREQUENCY RESPONSE vs VARIOUS  $\rm R_{LOAD}$ 

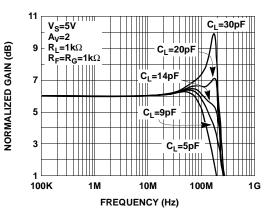
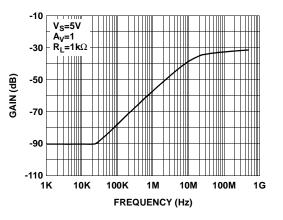
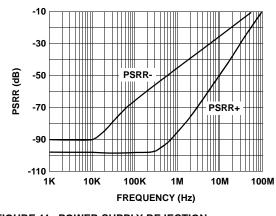
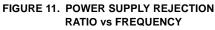


FIGURE 8. SMALL SIGNAL FREQUENCY RESPONSE FOR VARIOUS  $\rm C_L$ 









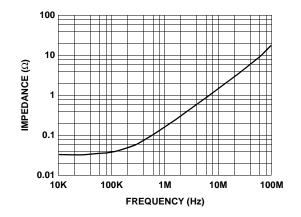


FIGURE 13. OUPUT IMPEDANCE vs FREQUENCY

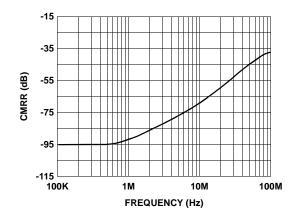


FIGURE 15. COMMON-MODE REJECTION RATIO vs FREQUENCY

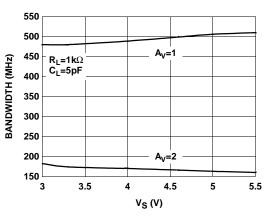


FIGURE 12. SMALL SIGNAL BANDWIDTH vs SUPPLY VOLTAGE

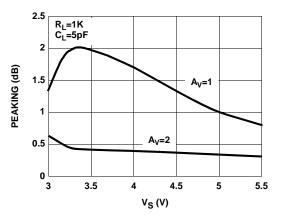


FIGURE 14. SMALL SIGNAL PEAKING vs SUPPLY VOLTAGE

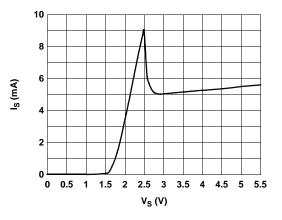


FIGURE 16. SUPPLY CURRENT vs SUPPLY VOLTAGE

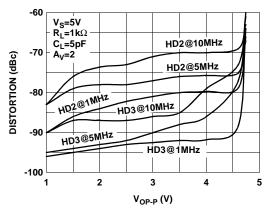


FIGURE 17. HARMONIC DISTORTION vs OUTPUT VOLTAGE

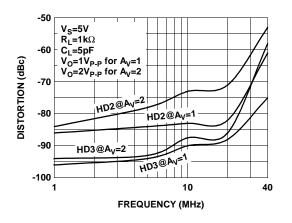


FIGURE 19. HARMONIC DISTORTION vs FREQUENCY

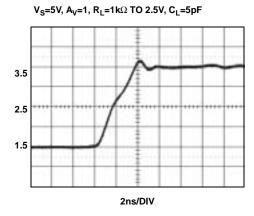


FIGURE 21. LARGE SIGNAL TRANSIENT RESPONSE - RISING

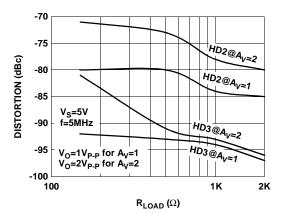
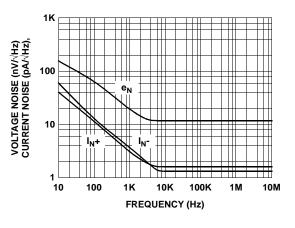
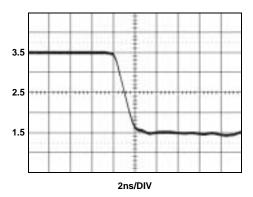


FIGURE 18. HARMONIC DISTORTION vs LOAD RESISTANCE

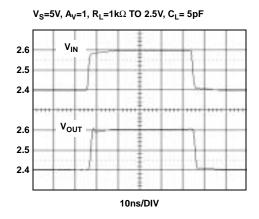




V\_S=5V, A\_V=1, R\_L=1k\Omega to 2.5V, CL=5pF

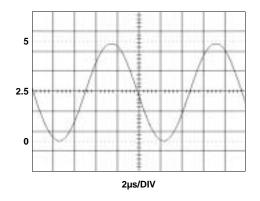




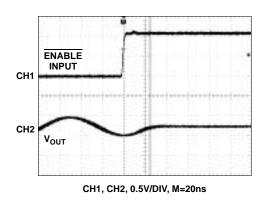


#### FIGURE 23. SMALL SIGNAL TRANSIENT REPONSE

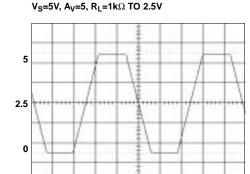




**FIGURE 25. OUTPUT SWING** 

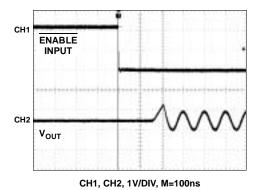


#### FIGURE 27. DISABLED RESPONSE



2µs/DIV

FIGURE 24. OUTPUT SWING



#### FIGURE 26. ENABLED RESPONSES

JEDEC JESD51-7 HIGH EFFECTIVE THERMAL CONDUCTIVITY TEST BOARD 1.4 1.2 POWER DISSIPATION (W) 1 - 909mW 0.8 SO8  $\theta_{JA}$ =110°C/W 0.6 435mW 0.4 SOT23-5/6 0.2 θ<sub>JA</sub>=230°C/W 0 0 25 50 75 85 100 125 150 AMBIENT TEMPERATURE (°C)



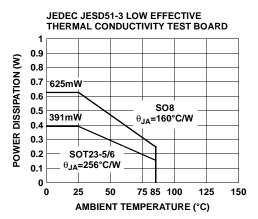


FIGURE 29. PACKAGE POWER DISSIPATION vs AMBIENT TEMPERATURE

# Description of Operation and Application Information

#### **Product Description**

The EL8102, EL8103 are wide bandwidth, single supply, low power and rail-to-rail output voltage feedback operational amplifiers. Both amplifiers are internally compensated for closed loop gain of +1 of greater. Connected in voltage follower mode and driving a  $1k\Omega$  load, the EL8102, EL8103 have a -3dB bandwidth of 500MHz. Driving a  $150\Omega$  load, the bandwidth is about 350MHz while maintaining a 600V/us slew rate. The EL8102 is available with a power down pin to reduce power to  $30\mu$ A typically while the amplifier is disabled.

#### Input, Output and Supply Voltage Range

The EL8102, EL8103 have been designed to operate with a single supply voltage from 3V to 5.0V. Split supplies can also be used as long as their total voltage is within 3V to 5.0V. The amplifiers have an input common mode voltage range from 0.15V below the negative supply (V<sub>S</sub>- pin) to within 1.5V of the positive supply (V<sub>S</sub>+ pin). If the input signal is outside the above specified range, it will cause the output signal to be distorted.

The output of the EL8102, EL8103 can swing rail to rail. As the load resistance becomes lower, the ability to drive close to each rail is reduced. For the load resistor  $1k\Omega$ , the output swing is about 4.9V at a 5V supply. For the load resistor  $150\Omega$ , the output swing is about 4.6V.

#### Choice of Feedback Resistor and Gain Bandwidth Product

For applications that require a gain of +1, no feedback resistor is required. Just short the output pin to the inverting input pin. For gains greater than +1, the feedback resistor forms a pole with the parasitic capacitance at the inverting input. As this pole becomes smaller, the amplifier's phase margin is reduced. This causes ringing in the time domain and peaking in the frequency domain. Therefore,  $R_F$  has some maximum value that should not be exceeded for optimum performance. If a large value of  $R_F$  must be used, a small capacitor in the few pF range in parallel with  $R_F$  can help to reduce the ringing and peaking at the expense of reducing the bandwidth.

As far as the output stage of the amplifier is concerned, the output stage is also a gain stage with the load.  $R_F$  and  $R_G$  appear in parallel with  $R_L$  for gains other than +1. As this combination gets smaller, the bandwidth falls off. Consequently,  $R_F$  also has a minimum value that should not be exceeded for optimum performance. For gain of +1,  $R_F$ =0 is optimum. For the gains other than +1, optimum response is obtained with  $R_F$  between 300 $\Omega$  to 1k $\Omega$ .

The EL8102, EL8103 have a gain bandwidth product of 200MHz. For gains  $\geq$ 5, its bandwidth can be predicted by the following equation:

 $Gain \times BW = 200MHz$ 

#### Video Performance

For good video performance, an amplifier is required to maintain the same output impedance and the same frequency response as DC levels are changed at the output. This is especially difficult when driving a standard video load of  $150\Omega$ , because the change in output current with DC level. Special circuitry has been incorporated in the EL8102, EL8103 to reduce the variation of the output impedance with the current output. This results in dG and dP specifications of 0.01% and  $0.01^\circ$ , while driving  $150\Omega$  at a gain of 2. Driving high impedance loads would give a similar or better dG and dP performance.

#### Driving Capacitive Loads and Cables

The EL8102, EL8103 can drive 10pF loads in parallel with 1k $\Omega$  with less than 5dB of peaking at gain of +1. If less peaking is desired in applications, a small series resistor (usually between 5 $\Omega$  to 50 $\Omega$ ) can be placed in series with the

output to eliminate most peaking. However, this will reduce the gain slightly. If the gain setting is greater than 1, the gain resistor  $R_G$  can then be chosen to make up for any gain loss which may be created by the additional series resistor at the output.

When used as a cable driver, double termination is always recommended for reflection-free performance. For those applications, a back-termination series resistor at the amplifier's output will isolate the amplifier from the cable and allow extensive capacitive drive. However, other applications may have high capacitive loads without a back-termination resistor. Again, a small series resistor at the output can help to reduce peaking.

#### Disable/Power-Down

The EL8102 can be disabled and placed its output in a high impedance state. The turn off time is about 25ns and the turn on time is about 200ns. When disabled, the amplifier's supply current is reduced to  $30\mu$ A typically, thereby effectively eliminating the power consumption. The amplifier's power down can be controlled by standard TTL or CMOS signal levels at the ENABLE pin. The applied logic signal is relative to V<sub>S</sub>- pin. Letting the ENABLE pin float or applying a signal that is less than 0.8V above V<sub>S</sub>- will enable the amplifier. The amplifier will be disabled when the signal at ENABLE pin is 2V above V<sub>S</sub>-.

#### **Output Drive Capability**

The EL8102, EL8103 do not have internal short circuit protection circuitry. They have a typical short circuit current of 80mA sourcing and 150mA sinking for the output is connected to half way between the rails with a 10 $\Omega$  resistor. If the output is shorted indefinitely, the power dissipation could easily increase such that the part will be destroyed. Maximum reliability is maintained if the output current never exceeds ±40mA. This limit is set by the design of the internal metal interconnections.

#### **Power Dissipation**

With the high output drive capability of the EL8102, EL8103, It is possible to exceed the 125°C absolute maximum junction temperature under certain load current conditions. Therefore, it is important to calculate the maximum junction temperature for the application to determine if the load conditions or package types need to be modified for the amplifier to remain in the safe operating area.

The maximum power dissipation allowed in a package is determined according to:

$$PD_{MAX} = \frac{T_{JMAX} - T_{AMAX}}{\theta_{JA}}$$

Where:

T<sub>JMAX</sub> = Maximum junction temperature

T<sub>AMAX</sub> = Maximum ambient temperature

 $\theta_{JA}$  = Thermal resistance of the package

The maximum power dissipation actually produced by an IC is the total quiescent supply current times the total power supply voltage, plus the power in the IC due to the load, or:

For sourcing:

$$PD_{MAX} = V_{S} \times I_{SMAX} + (V_{S} - V_{OUT}) \times \frac{V_{OUT}}{R_{I}}$$

For sinking:

 $PD_{MAX} = V_{S} \times I_{SMAX} + (V_{OUT} - V_{S}) \times I_{LOAD}$ 

Where:

V<sub>S</sub> = Total supply voltage

I<sub>SMAX</sub> = Maximum quiescent supply current

V<sub>OUT</sub> = Maximum output voltage of the application

R<sub>LOAD</sub> = Load resistance tied to ground

I<sub>LOAD</sub> = Load current

By setting the two  $PD_{MAX}$  equations equal to each other, we can solve the output current and  $R_{LOAD}$  to avoid the device overheat.

#### Power Supply Bypassing and Printed Circuit Board Layout

As with any high frequency device, a good printed circuit board layout is necessary for optimum performance. Lead lengths should be as short as possible. The power supply pin must be well bypassed to reduce the risk of oscillation. For normal single supply operation, where the V<sub>S</sub>- pin is connected to the ground plane, a single 4.7µF tantalum capacitor in parallel with a 0.1µF ceramic capacitor from V<sub>S</sub>+ to GND will suffice. This same capacitor combination should be placed at each supply pin to ground if split supplies are to be used. In this case, the V<sub>S</sub>- pin becomes the negative supply rail.

For good AC performance, parasitic capacitance should be kept to a minimum. Use of wire wound resistors should be avoided because of their additional series inductance. Use of sockets should also be avoided if possible. Sockets add parasitic inductance and capacitance that can result in compromised performance. Minimizing parasitic capacitance at the amplifier's inverting input pin is very important. The feedback resistor should be placed very close to the inverting input pin. Strip line design techniques are recommended for the signal traces.

#### **Typical Applications**

#### VIDEO SYNC PULSE REMOVER

Many CMOS analog to digital converters have a parasitic latch up problem when subjected to negative input voltage levels. Since the sync tip contains no useful video information and it is a negative going pulse, we can chop it off. Figure 30 shows a gain of 2 connections for EL8102, EL8103. Figure 31 shows the complete input video signal applied at the input, as well as the output signal with the negative going sync pulse removed.

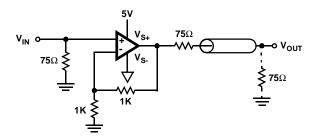
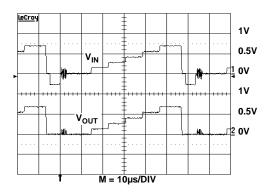


FIGURE 30. SYNC PULSE REMOVER





#### MULTIPLEXER

Besides the normal power down usage, the ENABLE pin of the EL8102 can be used for multiplexing applications. Figure 32 shows two EL8102 with the outputs tied together, driving a back terminated 75 $\Omega$  video load. A  $2V_{P-P}$  2MHz sine wave is applied to Amp A and a  $1V_{P-P}$  2MHz sine wave is applied to Amp B. Figure 33 shows the ENABLE signal and the resulting output waveform at  $V_{OUT}$ . Observe the breakbefore-make operation of the multiplexing. Amp A is on and  $V_{IN1}$  is passed through to the output when the ENABLE signal is low and turns off in about 25ns when the ENABLE signal is high. About 200ns later, Amp B turns on and  $V_{IN2}$  is passed through to the output. The break-before-make operation ensures that more than one amplifier isn't trying to drive the bus at the same time.

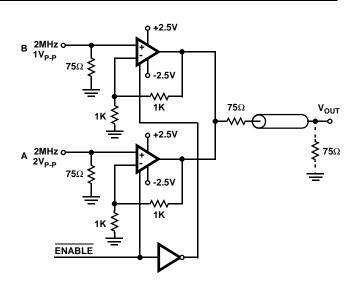
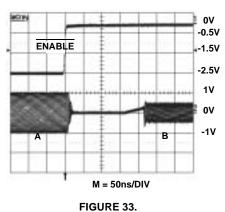
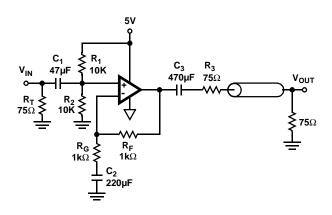


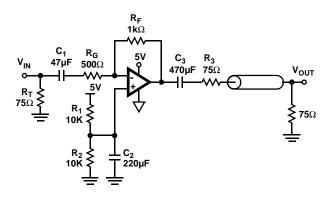
FIGURE 32. TWO TO ONE MULTIPLEXER



#### SINGLE SUPPLY VIDEO LINE DRIVER

The EL8102 and EL8103 are wideband rail-to-rail output op amplifiers with large output current, excellent dG, dP, and low distortion that allow them to drive video signals in low supply applications. Figure 34 is the single supply non-inverting video line driver configuration and Figure 35 is the inverting video ling driver configuration. The signal is AC coupled by C<sub>1</sub>. R<sub>1</sub> and R<sub>2</sub> are used to level shift the input and output to provide the largest output swing. R<sub>F</sub> and R<sub>G</sub> set the AC gain. C<sub>2</sub> isolates the virtual ground potential. R<sub>T</sub> and R<sub>3</sub> are the termination resistors for the line. C<sub>1</sub>, C<sub>2</sub> and C<sub>3</sub> are selected big enough to minimize the droop of the luminance signal.





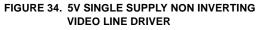


FIGURE 35. SINGLE SUPPLY INVERTING VIDEO LINE DRIVER

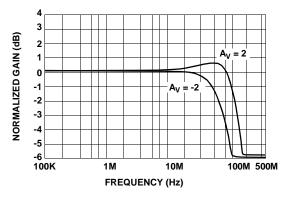


FIGURE 36. VIDEO LINE DRIVER FREQUENCY RESPONSE

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